

## Absolute Maximum Ratings

$V_{DD}$  to GND ..... -0.3V to +6.0V  
 $RS+$ ,  $RS-$  to GND ..... -0.3V to +80V  
 $RS+$  to  $RS-$  (Continuous) .....  $\pm 24V$   
 Continuous (> 1s) Input Current (Any Pin) .....  $\pm 10mA$

Operating Temperature Range .....  $-40^{\circ}C$  to  $+125^{\circ}C$   
 Junction Temperature .....  $+150^{\circ}C$   
 Storage Temperature Range .....  $-65^{\circ}C$  to  $+150^{\circ}C$   
 Reflow Soldering Peak Temperature (Pb-free) .....  $+260^{\circ}C$

## Package Thermal Characteristics (Note 1)

### 6-Bump WLP

Continuous Power Dissipation  
 (Derate  $mW/^{\circ}C$  above  $+70^{\circ}C$ ) ..... 12.34mW  
 Junction-to-Ambient Thermal Resistance ( $\theta_{JA}$ ) .....  $81.03^{\circ}C/W$

### 6-Pin SOT23

Continuous Power Dissipation  
 (Derate  $mW/^{\circ}C$  above  $+70^{\circ}C$ ) ..... 13.40mW  
 Junction-to-Ambient Thermal Resistance ( $\theta_{JA}$ ) .....  $74.60^{\circ}C/W$   
 Junction-to-Case Thermal Resistance ( $\theta_{JC}$ ) .....  $6.0^{\circ}C/W$

**Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to [www.maximintegrated.com/thermal-tutorial](http://www.maximintegrated.com/thermal-tutorial).

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Electrical Characteristics

( $V_{RS+} = V_{RS-} = +36V$ ,  $V_{DD} = +3.3V$ ,  $V_{SENSE} = V_{RS+} - V_{RS-} = 1mV$ ,  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$  unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>DC CHARACTERISTICS</b>						
Supply Voltage	$V_{DD}$	Guaranteed by PSRR	2.7		5.5	V
Supply Current	$I_{DD}$	$T_A = +25^{\circ}C$		350		$\mu A$
		$-40^{\circ}C < T_A < +125^{\circ}C$			800	
Power-Supply Rejection Ratio	PSRR	$2.7V \leq V_{DD} \leq 5.5V$	110	120		dB
Input Common-Mode Voltage Range	$V_{CM}$	Guaranteed by CMRR	2.7		76	V
Input Bias Current at $V_{RS+}$ and $V_{RS-}$	$I_{RS+}$ , $I_{RS-}$				65	$\mu A$
Input Offset Current	$I_{RS+} - I_{RS-}$				400	nA
Input Leakage Current	$I_{RS+}$ , $I_{RS-}$	$V_{DD} = 0V$ , $V_{RS+} = 76V$			5	$\mu A$
Common-Mode Rejection Ratio	CMRR	$+4.5V < V_{RS+} < +76V$	125	140		dB
Input Offset Voltage	$V_{OS}$	$T_A = +25^{\circ}C$			$\pm 12$	$\mu V$
		$-40^{\circ}C \leq T_A \leq +85^{\circ}C$			$\pm 25$	
		$-40^{\circ}C \leq T_A \leq +125^{\circ}C$			$\pm 25$	
Input Offset Voltage Drift	$TCV_{OS}$				130	$nV/^{\circ}C$
Input Sense Voltage	$V_{SENSE}$	MAX40010L ( $G = 12.5V/V$ )		200		mV
		MAX40010T ( $G = 20V/V$ )		125		
		MAX40010F ( $G = 50V/V$ )		50		
		MAX40010H ( $G = 100V/V$ )		25		

## Electrical Characteristics (continued)

( $V_{RS+} = V_{RS-} = +36V$ ,  $V_{DD} = +3.3V$ ,  $V_{SENSE} = V_{RS+} - V_{RS-} = 1mV$ ,  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$  unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Gain (Note 3)	G	Full-Scale $V_{SENSE} = 200mV$		12.5		V/V
		Full-Scale $V_{SENSE} = 125mV$		20		
		Full-Scale $V_{SENSE} = 50mV$		50		
		Full-Scale $V_{SENSE} = 25mV$		100		
Gain Error	GE	$T_A = +25^{\circ}C$			0.1	%
		$-40^{\circ}C \leq T_A \leq +85^{\circ}C$			0.5	
		$-40^{\circ}C \leq T_A \leq +125^{\circ}C$			0.7	
Output Resistance	$R_{OUT}$			0.1		m $\Omega$
Output Low Voltage	$V_{OL}$	Sink 500 $\mu A$			15	mV
Output High Voltage	$V_{OH}$	Source 500 $\mu A$	$V_{DD} - 0.016$			V
<b>AC CHARACTERISTICS</b>						
Signal Bandwidth	BW -3dB	Gain = 50V/V Configuration $V_{SENSE} > 5mV$		80		kHz
AC Power Supply Rejection Ratio	AC PSRR	$f = 200kHz$		40		dB
AC CMRR	AC CMRR	$f = 200kHz$		48		dB
Output Transient Recovery Time		$\Delta V_{OUT} = 2V_{P-P}$ , 0.1% final $V_{OUT}$ settling with 400 $\Omega$ and 1nF onto 6pF ADC input sampling capacitor		2		$\mu s$
Capacitive Load Stability	$C_{LOAD}$	With 240 $\Omega$ isolation resistor		20		nF
		Without any isolation resistor		200		pF
Input Voltage Noise Density	$e_n$	$f = 1kHz$		65		nV/ $\sqrt{Hz}$
Total Harmonic Distortion	THD	$f = 1kHz$ , $V_{OUT} = 1V_{P-P}$		60		dB
Power-Up Time (Note 4)				200		$\mu s$
Saturation Recovery Time				10		$\mu s$

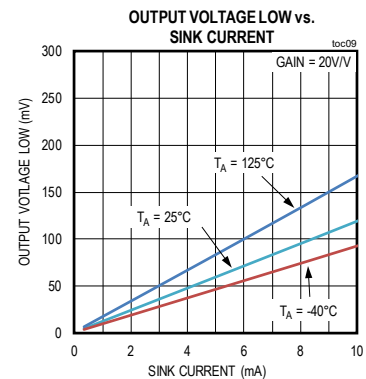
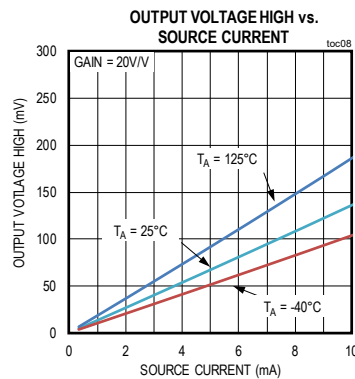
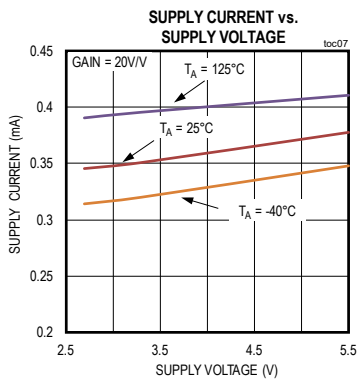
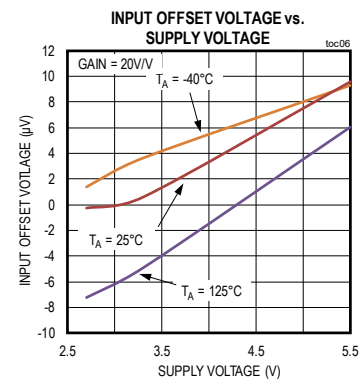
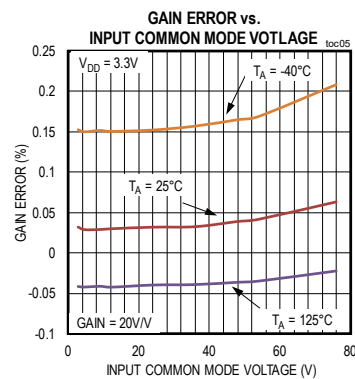
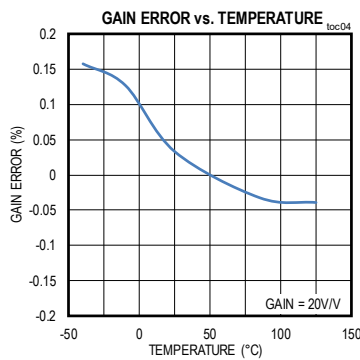
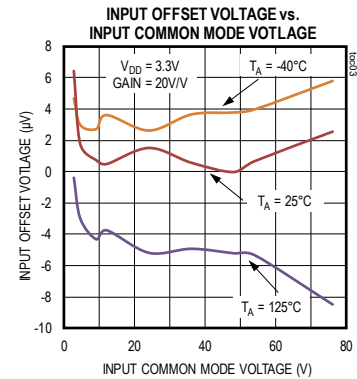
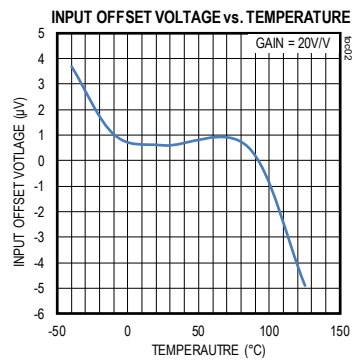
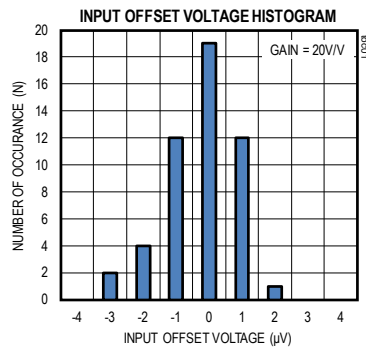
**Note 2:** All devices are 100% production tested at  $T_A = +25^{\circ}C$ . All temperature limits are guaranteed by design.

**Note 3:** Gain and offset voltage are calculated based on two point measurements:  $V_{SENSE1} = 20\%$  full scale and  $V_{SENSE2} = 80\%$  full scale.

**Note 4:** Output is high-Z during power-up.

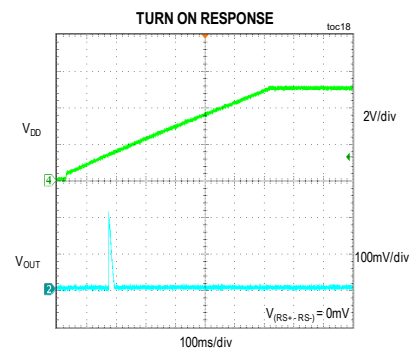
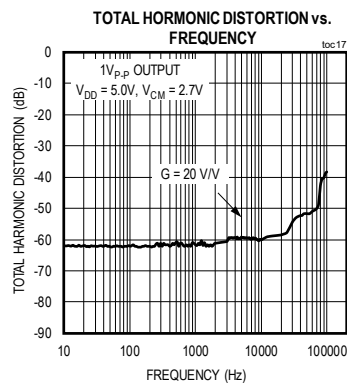
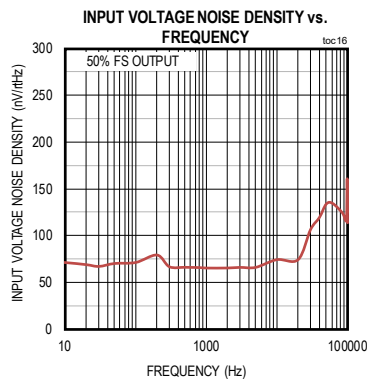
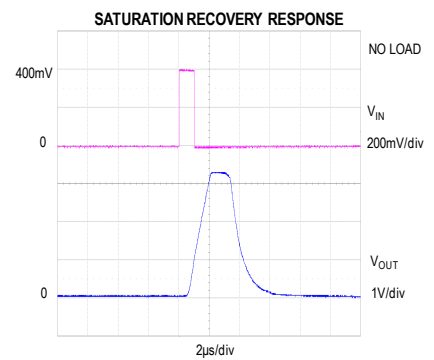
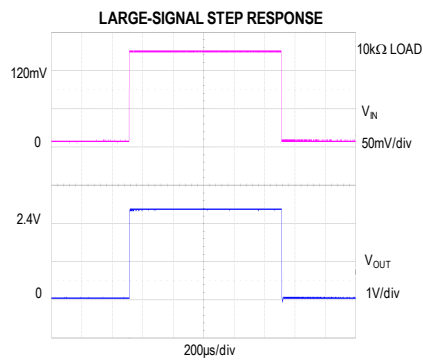
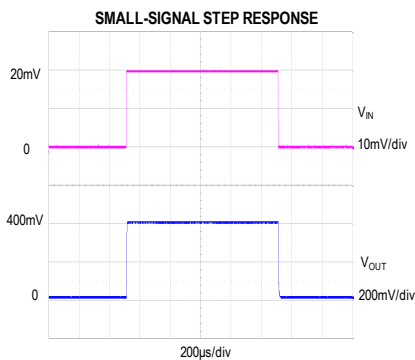
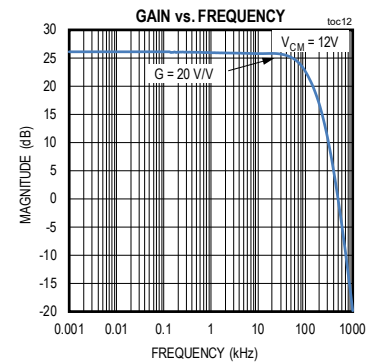
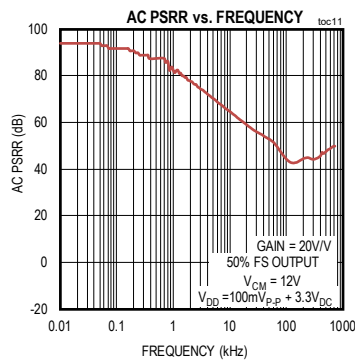
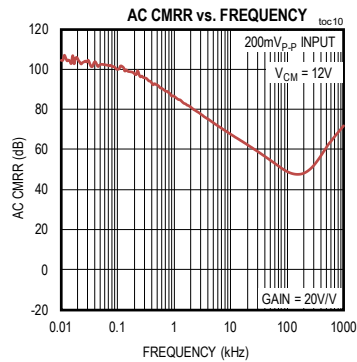
## Typical Operating Characteristics

( $V_{RS+} = V_{RS-} = +36V$ ,  $V_{DD} = +3.3V$ ,  $V_{SENSE} = V_{RS+} - V_{RS-} = 1mV$ ,  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .)



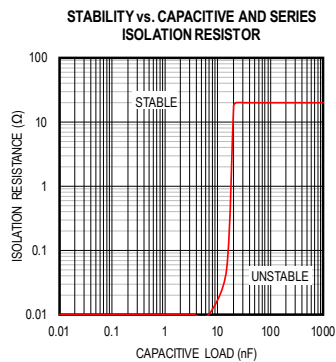
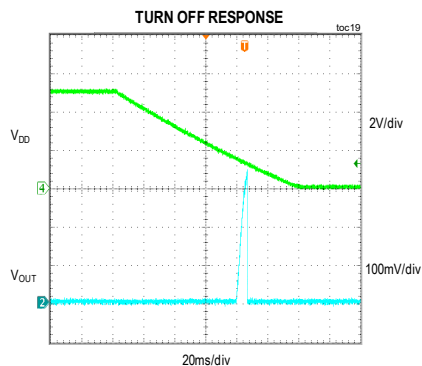
## Typical Operating Characteristics (continued)

( $V_{RS+} = V_{RS-} = +36V$ ,  $V_{DD} = +3.3V$ ,  $V_{SENSE} = V_{RS+} - V_{RS-} = 1mV$ ,  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .)

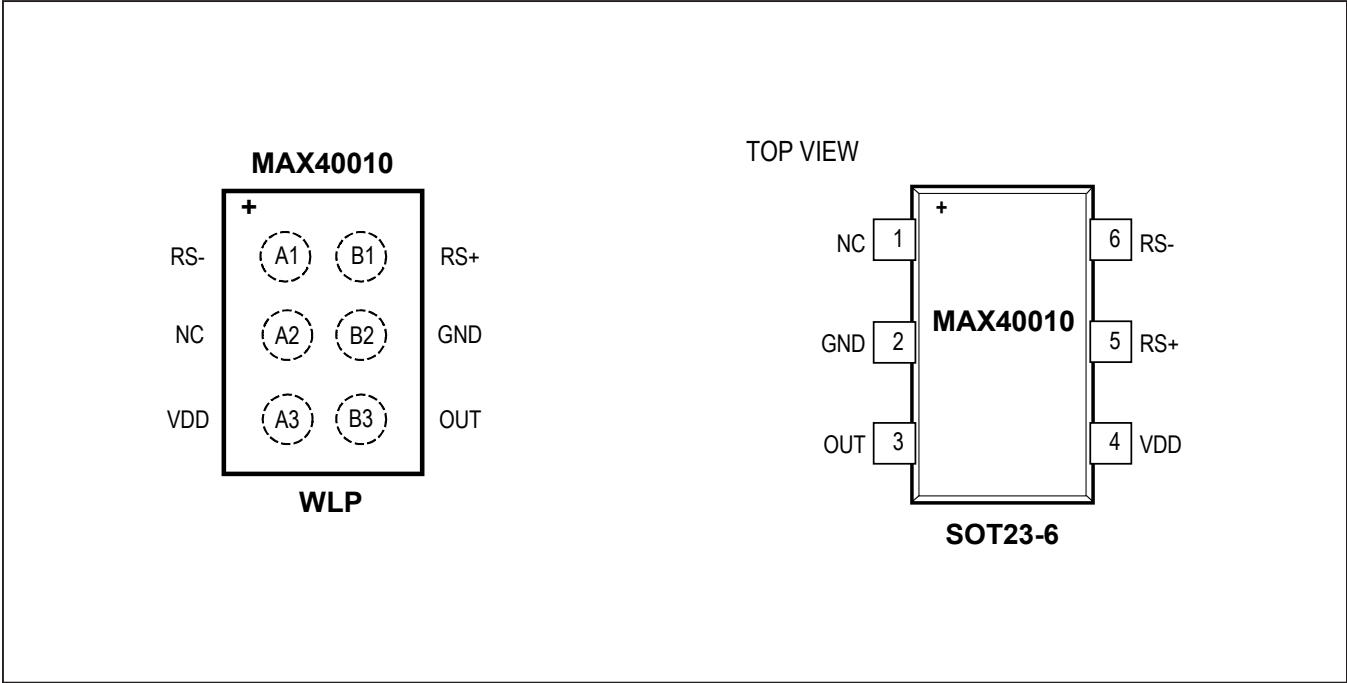


**Typical Operating Characteristics (continued)**

( $V_{RS+} = V_{RS-} = +36V$ ,  $V_{DD} = +3.3V$ ,  $V_{SENSE} = V_{RS+} - V_{RS-} = 1mV$ ,  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .)



Pin Configurations



Pin Description

PIN		NAME	FUNCTION
WLP	SOT23		
B1	5	RS+	External Resistor Power-Side Connection Input
A1	6	RS-	External Resistor Load-Side Connection Input
A3	4	VDD	Supply Voltage Input
B2	2	GND	Ground or Supply Return Input
B3	3	OUT	Output. Output is proportional to the magnitude of differential sense input voltage.
A2	1	NC	No Connect.

## Functional (or Block) Diagram

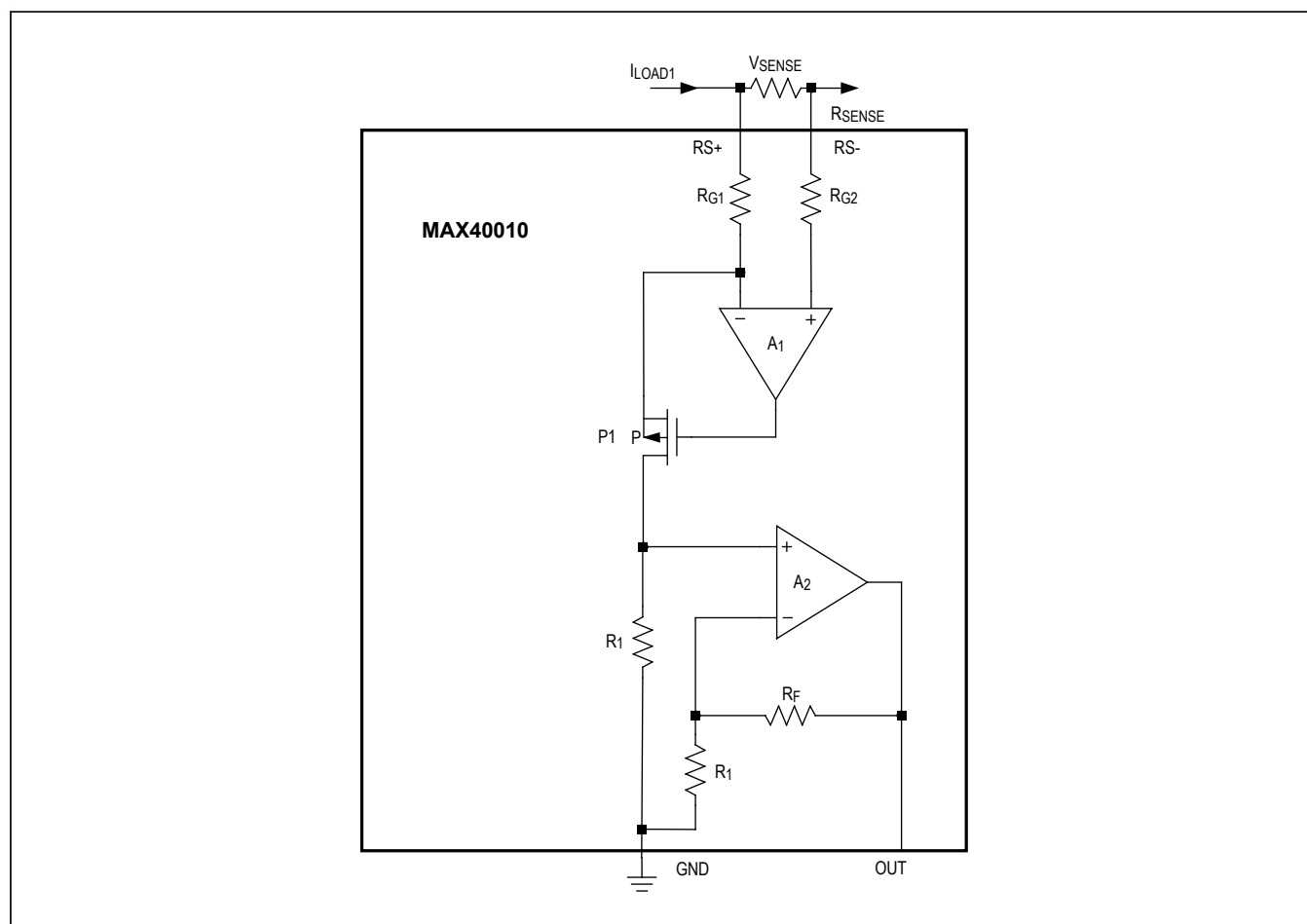


Figure 1. MAX40010 Functional Diagram

## Detailed Description

The MAX40010 high-side, current-sense amplifier features a 2.7V to 76V input common-mode range that is independent of supply voltage. This feature allows the monitoring of current out of a battery as low as 2.7V and enables high-side current sensing at voltages greater than the supply voltage ( $V_{DD}$ ). The MAX40010 monitors current through an external current-sense resistor and amplifies the voltage across the resistor.

High-side current monitoring does not interfere with the ground path of the load being measured, making the MAX40010 particularly useful in a wide range of high-voltage systems.

The MAX40010 operates as follows: current from the source flows through  $R_{SENSE}$  to the load (Figure 1), creating a sense voltage,  $V_{SENSE}$ . The internal op amp A1 forces the current through an internal gain resistor  $RG1$  at  $RS+$  input, such that its voltage drop equals the voltage drop ( $V_{SENSE}$ ) across the external sense resistors ( $R_{SENSE}$ ). The internal resistor at  $RS-$  input ( $RG2$ ) has the same value as  $RG1$  to minimize the error. The current through  $RG1$  is sourced by a high-voltage p-channel FET. Its source current is the same as the drain current which flows through a second gain resistor,  $R1$ , producing a voltage  $VR1 = V_{SENSE} \times R1 / RG1$ .

The output voltage  $V_{OUT}$  is produced from a second op amp A2 with the gain  $(1 + RF1 / R1)$ . Hence the  $V_{OUT} = I_{LOAD} \times R_{SENSE} (R1 / RG1) \times (1 + RF1 / R1)$ . The value of internal resistors  $R1$ ,  $R2$ ,  $RG1$ ,  $RG2$ ,  $RF$  are available in Table 1.

Total gain is 12.5V/V for MAX40010L, 20V/V for the MAX40010T, 50V/V for the MAX40010F, and 100V/V for the MAX40010H.

## Application Information

### Recommended Component Values

Ideally, the maximum load current develops the full-scale sense voltage across the current-sense resistor. Choose the gain needed to yield the maximum output voltage required for the application:

$$V_{OUT} = V_{SENSE} \times AV$$

where  $V_{SENSE}$  is the full-scale sense voltage, 200mV for gain of 12.5V/V, 125mV for gain of 20V/V, 50mV for gain of 50V/V, 25mV for gain of 100V/V, and  $AV$  is the gain of the device.

In applications monitoring a high current, ensure that  $R_{SENSE}$  is able to dissipate its own  $I^2R$  loss. If the resistor's power dissipation exceeds the nominal value, its value may drift or it may fail altogether.

The MAX40010 sense a wide variety of currents with different sense-resistor values.

### Choosing the Sense Resistor

Choose  $R_{SENSE}$  based on the following criteria:

- **Voltage Loss:** A high  $R_{SENSE}$  value causes the power-source voltage to degrade through  $IR$  loss. For minimal voltage loss, use the lowest  $R_{SENSE}$  value.
- **Accuracy:** A high  $R_{SENSE}$  value allows lower currents measured more accurately. This is due to offsets becoming less significant when the sense voltage is larger. For best performance, select  $R_{SENSE}$  to provide approximately 200mV (gain of 12.5V/V), 125mV (gain of 20V/V), or 50mV (gain of 50V/V), 25mV (gain of 100V/V) of sense voltage for the full-scale current in each application.

**Table 1. Internal Gain-Setting Resistors**

	GAIN (V/V)	R1, R2 (kΩ)	RG1, RG2 (kΩ)	RF (kΩ)
MAX40010L	12.5	25	10	100
MAX40010T	20	25	10	175
MAX40010F	50	25	10	475
MAX40010H	100	25	10	975

• **Efficiency and Power Dissipation:** At high current levels, the  $I^2R$  losses in  $R_{SENSE}$  can be significant. Consider this when choosing the resistor value and its power dissipation (wattage) rating. In addition, the sense resistor's value might drift if it heats up excessively.

• **Inductance:** Keep inductance low if  $I_{SENSE}$  has a large high-frequency component. Wire-wound resistors have the highest inductance, while metal film is somewhat better. Low-inductance, metal-film resistors are also available. Instead of being spiral wrapped around a core, as in metal-film or wire wound resistors, they are a straight band of metal and are available in values under  $1\Omega$ .

Take care to eliminate parasitic trace resistance from causing errors in the sense voltage because of the high currents that flow through  $R_{SENSE}$ . Either use a four-terminal current-sense resistor or use Kelvin (force and sense) PC board layout techniques.

## EMIRR Input Filter

These devices have input EMI filters to prevent effects of radio frequency interference on the output. The EMI filters comprise passive devices that present significant higher impedance to RF signals. See the EMIRR vs. Frequency plot in the [Typical Operating Characteristics](#) section for details.

## Typical Application Circuit

An example of typical application ([Figure 2](#)) of this high-voltage, high-precision current-sense amplifier is in base station systems where there is a need to monitor the current flowing in the power amplifier. Such an amplifier, depending on the technology, can be biased up to 50V or 60V thus requiring a current-sense amplifier like the MAX40010 with high voltage common mode. The very low input offset voltage of the MAX40010 minimizes the value of the external sense resistor, resulting in system power saving.

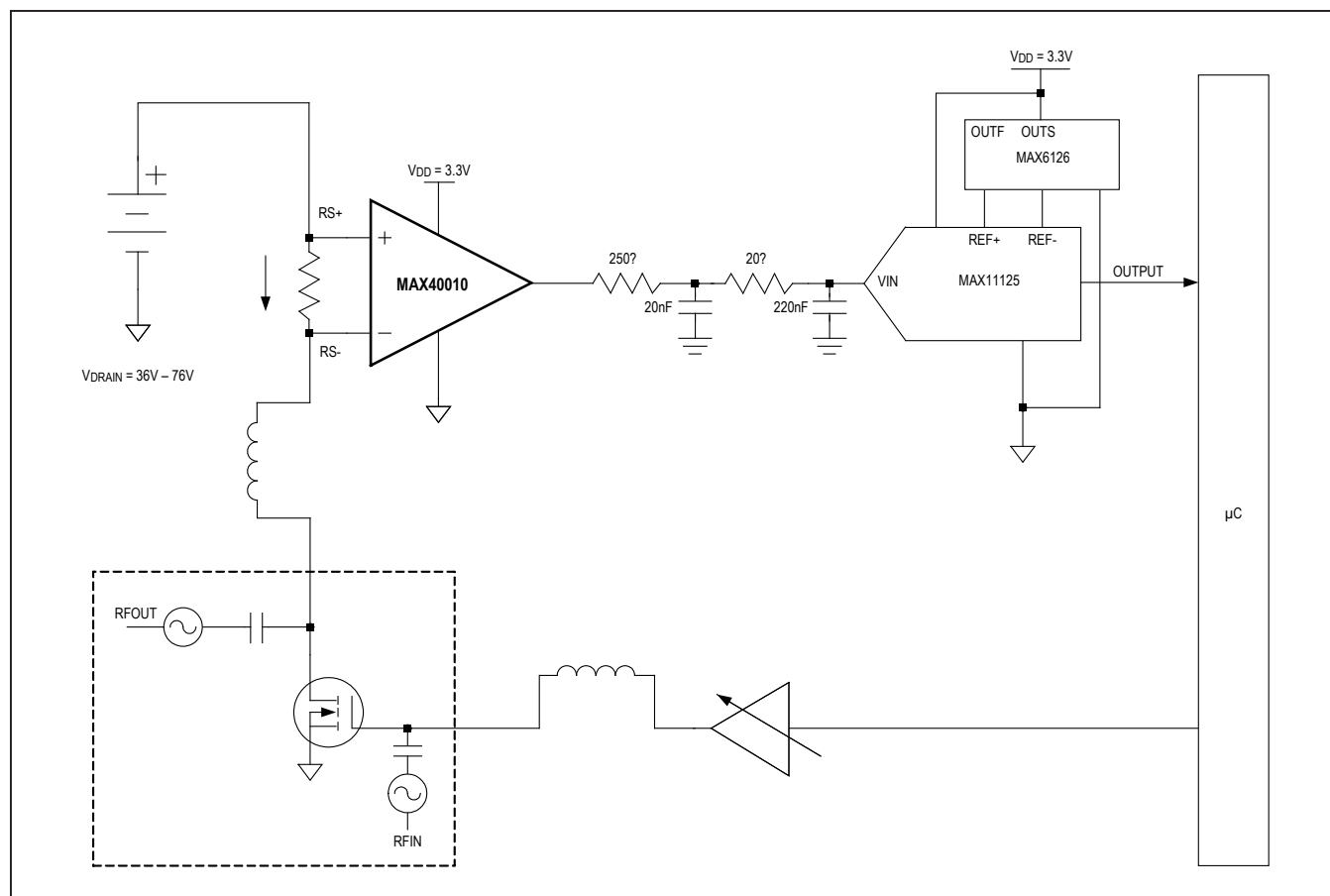


Figure 2. MAX40010 Used in Base Station Application

### Turn On/Off Response

The internal POR (Power on Reset) structure creates the inadvertent glitch, as shown in TOC18 and TOC19: typical turn on and turn off response of MAX40010. The internal POR event takes place below minimum  $V_{CC}$  supply voltage (2.7V) around 1.7V. During this event the bias generators are defined, the internal blocks are set to known state and as a result, an output ( $V_{OUT}$ ) glitch is observed. The device may take tens of  $\mu s$  to settle to final value during power on and less than 10ms to settle during turn off.

### Output Filtering

To avoid output noise and transient overshoot, an RC filter with  $R = 500\Omega$  and  $C_L = 14.7nF$  at the output is recommended (Figure 3). This also benefits when the current sense amplifier is connected to a sample and hold ADC's, where the  $C_L$  will act as a charge reservoir during sample phase. when choosing different values of  $R$  and  $C_L$ , refer to TOC20 (Stability vs. Isolation Resistance and Capacitive Load) for more information.

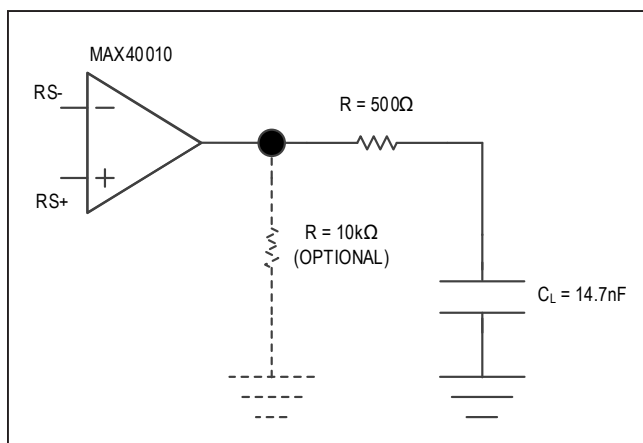


Figure 3. Optional Output Filtering

## Ordering Information

PART	GAIN (V/V)	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX40010LAUT+	12.5	-40°C to +125°C	6 SOT23	+ACUR
MAX40010LAUT+T	12.5	-40°C to +125°C	6 SOT23	+ACUR
MAX40010LAWT+	12.5	-40°C to +125°C	6 WLP	+DX
MAX40010LAWT+T	12.5	-40°C to +125°C	6 WLP	+DX
MAX40010TAUT+	20	-40°C to +125°C	6 SOT23	+ACUS
MAX40010TAUT+T	20	-40°C to +125°C	6 SOT23	+ACUS
MAX40010TAWT+*	20	-40°C to +125°C	6 WLP	+DY
MAX40010TAWT+T*	20	-40°C to +125°C	6 WLP	+DY
MAX40010FAUT+	50	-40°C to +125°C	6 SOT23	+ACUT
MAX40010FAUT+T	50	-40°C to +125°C	6 SOT23	+ACUT
MAX40010FAWT+*	50	-40°C to +125°C	6 WLP	+DV
MAX40010FAWT+T*	50	-40°C to +125°C	6 WLP	+DV
MAX40010HAUT+	100	-40°C to +125°C	6 SOT23	+ACUU
MAX40010HAUT+T	100	-40°C to +125°C	6 SOT23	+ACUU
MAX40010HAWT+*	100	-40°C to +125°C	6 WLP	+DW
MAX40010HAWT+T*	100	-40°C to +125°C	6 WLP	+DW

\*Future product—contact factory for availability.

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = tape and reel.

## Package Information

For the latest package outline information and land patterns (footprints), go to [www.maximintegrated.com/packages](http://www.maximintegrated.com/packages). Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
6 WLP	W61K1+1	<a href="#">21-100121</a>	Refer to <a href="#">Application Note 1891</a>
6 SOT23	U6SN+1	<a href="#">21-0058</a>	<a href="#">91-0175</a>

## Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	7/17	Initial release	—
1	10/17	Changed future product status for MAX40010LAUT+, MAX40010TAUT+, and MAX40010HAUT+ in <i>Ordering Information</i> table	10
2	1/18	Added TOCs 18–20, added “Turn On/Off” and “Output Filtering” sections, and Figure 3	5, 6, 9, 10
3	10/18	Updated <i>Ordering Information</i>	12
4	7/20	Updated <i>Ordering Information</i>	12
5	10/20	Updated <i>EC Table</i>	3

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